

11-25-2003

Docket No.: 42534-9600

SHEET

U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office



Y

Tab settings → → → ▼ ▼ ▼ ▼ ▼

102608591

To the Director of the United States Patent and Trademark Office: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Hiromi Fujisawa

11-18-03

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: Kaijo Corporation

Address: 1-5, Sakaecho 3-chome, Hamura-shi

City: Tokyo

State/Prov.:

Country: Japan

ZIP:

Additional name(s) & address(es)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: November 11, 2003

4. Application number(s) or patent numbers(s):

10715990

If this document is being filed together with a new application, the execution date of the application is: November 11, 2003

Patent Application No.

Filing date

B. Patent No.(s)

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Joseph W. Price

Registration No. 25,124

Address: SNELL & WILMER LLP

1920 Main Street, Suite 1200

City: Irvine

State/Prov.: CA

Country: USA

ZIP: 92614

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account

☒ Authorized to be charged to deposit account

8. Deposit account number:

19-2814

(Attach duplicate copy of this page if paying by deposit account)

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Joseph W. Price

Name of Person Signing

Signature

November 18, 2003

Date

Total number of pages including cover sheet, attachments, and

Mail documents to be recorded with required cover sheet information to:
Mail Stop Assignment Recordation Services
Director of the United States Patent and Trademark Office
P.O. Box 1450, Alexandria, VA 22313-1450

PATENT

REEL: 014716 FRAME: 0637

U.S. PTO
22388
10/715990

10715990

19-2814

11/24/2003 LMEILLER 00000099 19514

40:00 DA
01 FC:0021

ASSIGNMENT

WHEREAS, I/~~we~~, Hiromi FUJISAWA,
(hereinafter "Assignor(s)"), citizen(s) of Japan, have invented
certain new and useful improvements in a Wire loop, semiconductor
device having same, wire bonding method and wire bonding apparatus
for which I/~~we~~ have executed application for Letters Patent of the
United States, of even date herewith, and

WHEREAS, KAIJO CORPORATION
(hereinafter "Assignee"), a corporation of Japan, having a
principal place of business at _____
1-5, Sakaecho 3-chome, Hamura-shi, Tokyo, Japan
is desirous of obtaining the entire right, title and interest in,
to and under the said improvements and the said application,

NOW, THEREFORE, in consideration of the sum of One
Hundred Yen (¥100), to me/~~us~~ in hand paid, and other good and
valuable consideration, the receipt of which is hereby
acknowledged, I/~~we~~, the Assignor(s) have sold, assigned,
transferred and set over, unto said Assignee, its successors,
legal representatives and assigns, the entire right, title and
interest in, to and under said improvements, and said application
and all divisions, renewals and continuations thereof, and all
Letters Patents of the United States, which may be granted thereon
and all reissues and extensions thereof, and all priority rights
under the International Convention for the Protection of
Industrial Property for every country of the Union, and all
applications for Letters Patents which may hereafter be filed for
said improvements in any country or countries foreign to the
United States, and all Letters Patents which may be granted for
said improvements in any country or countries foreign to the
United States, and any official of any country or countries
foreign to the United States, whose duty it is to issue patents,
on applications as aforesaid, to issue all Letters Patents for
said improvements to said Assignee, its successors, legal
representatives and assigns, in accordance with the terms of this
instrument.

AND I/~~WE~~ HEREBY covenant that I/~~we~~ have full right to
convey the entire interest herein assigned, and that I/~~we~~ have not
executed, and will not execute, any agreement in conflict herewith.

AND I/~~WE~~ HEREBY further covenant and agree that I/~~we~~
will communicate to said Assignee, its successors, legal
representatives and assigns, any facts known to me/~~us~~ respecting
said improvements, and testify in any legal proceeding, sign all
lawful papers, execute all divisional, continuing and reissue
applications, make all rightful oaths and generally do everything

possible to aid said Assignee, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand this 11th
day of November, 2003.

Hiromi Fujisawa
(Inventor) Hiromi FUJISAWA